

FIG. 1 is a cross-sectional view of a semiconductor device. The device includes a substrate 10, a first layer 12, and a second layer 26. A first conductive layer 14 is formed on the first layer 12, and a second conductive layer 16 is formed on the second layer 26. The first conductive layer 14 is wider than the second conductive layer 16. A dimension line W_1 indicates the width of the first conductive layer 14.

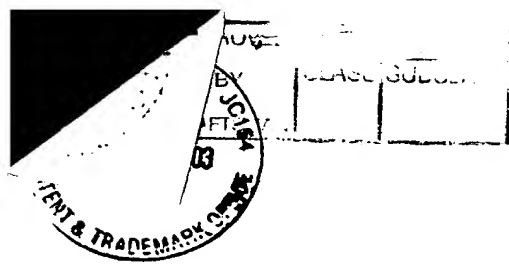


FIG.2(A)

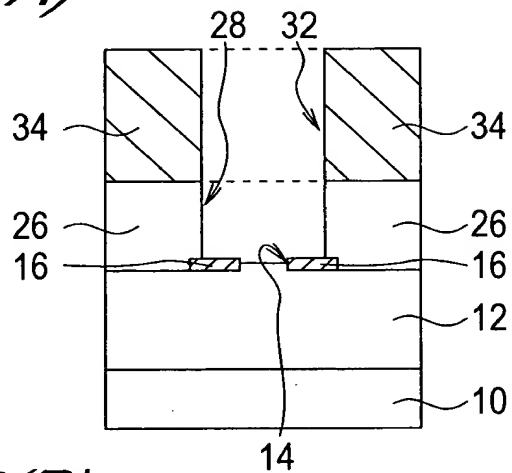
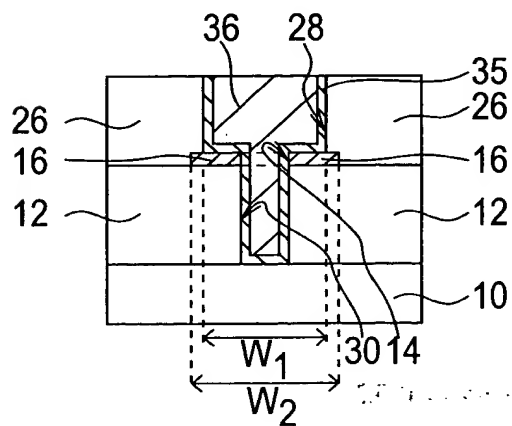
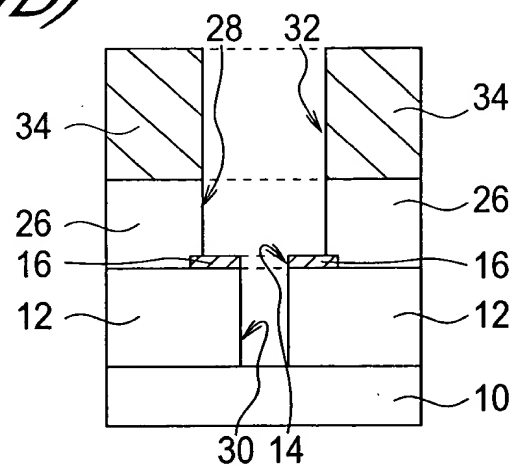


FIG.2(B)



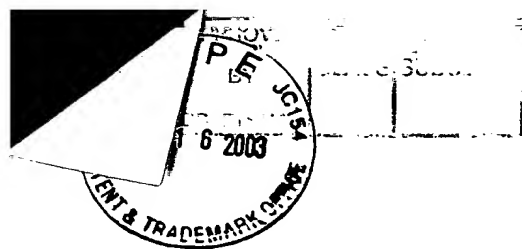


FIG. 3(A)

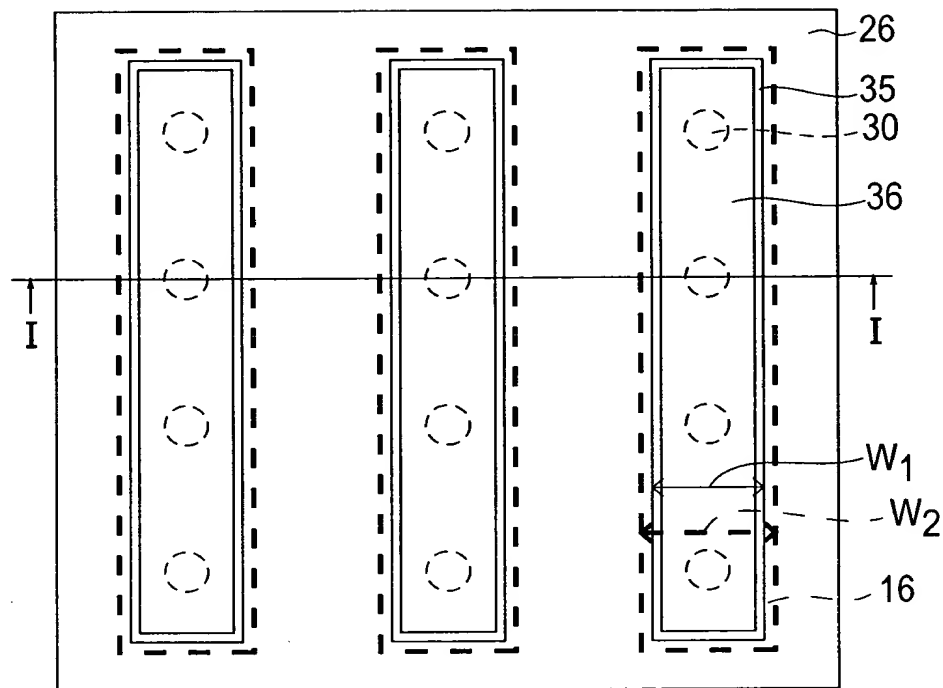
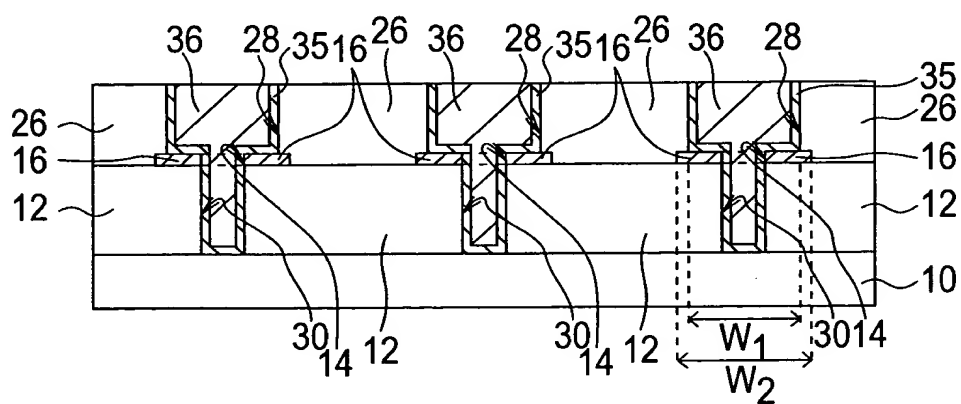


FIG. 3(B)



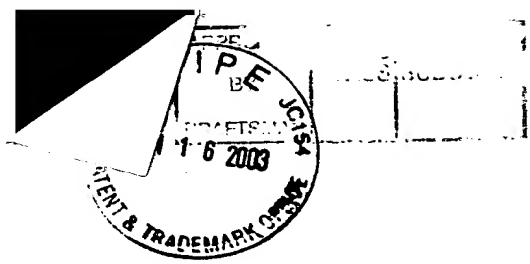
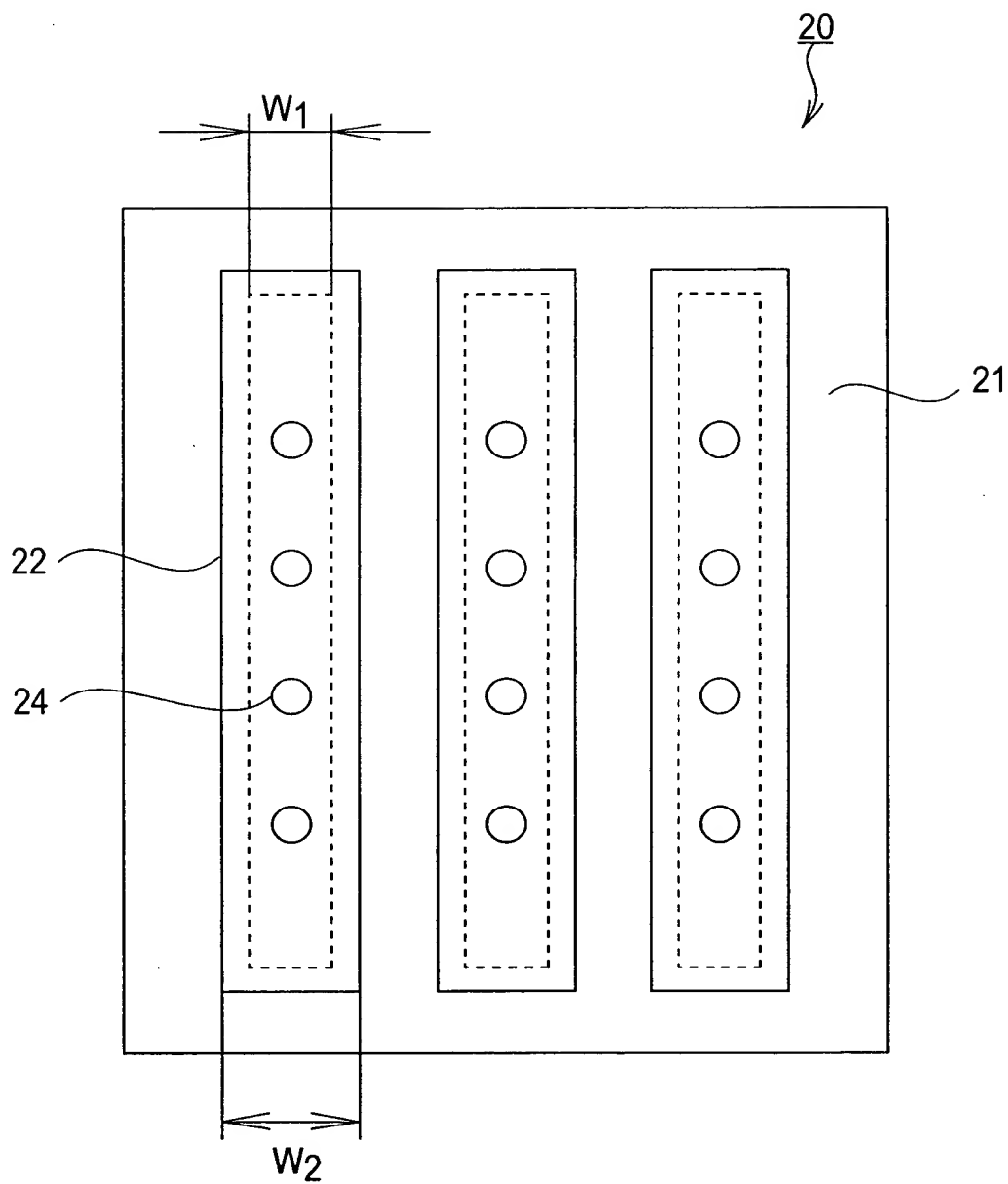


FIG. 4



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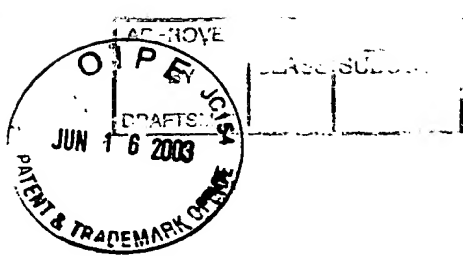


FIG. 6(A)

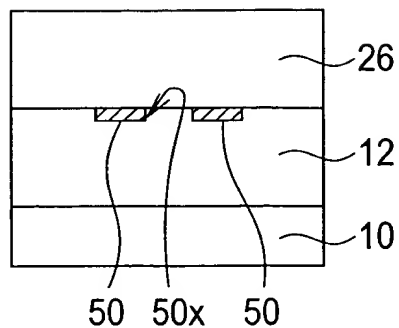


FIG. 6(B)

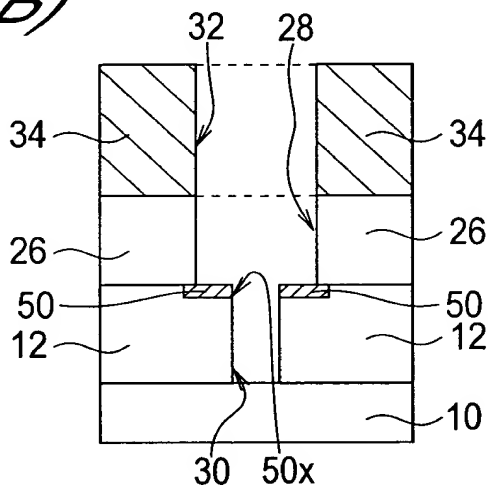
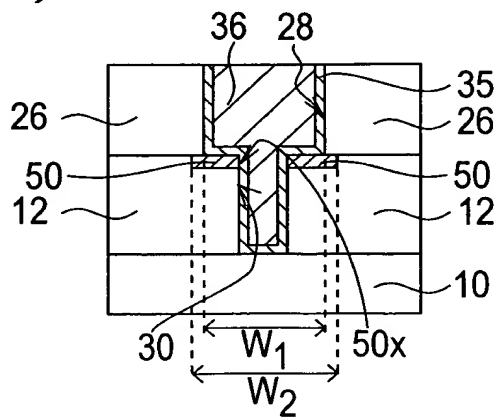


FIG. 6(C)



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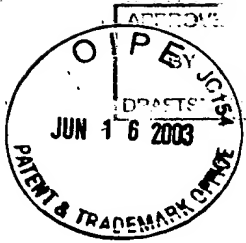


FIG. 8(A)

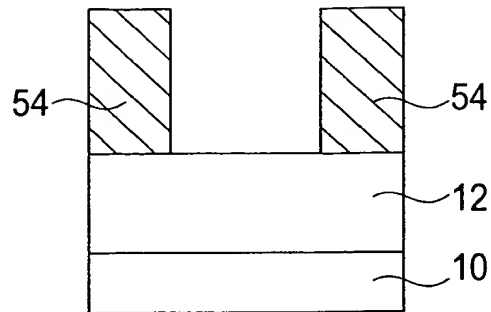


FIG. 8(B)

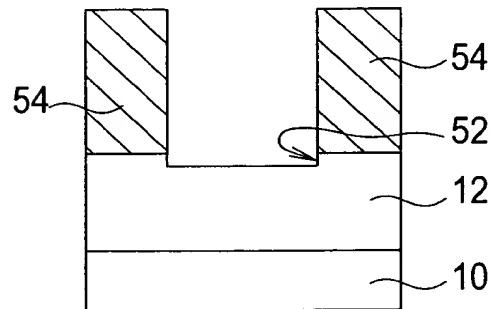


FIG. 8(C)

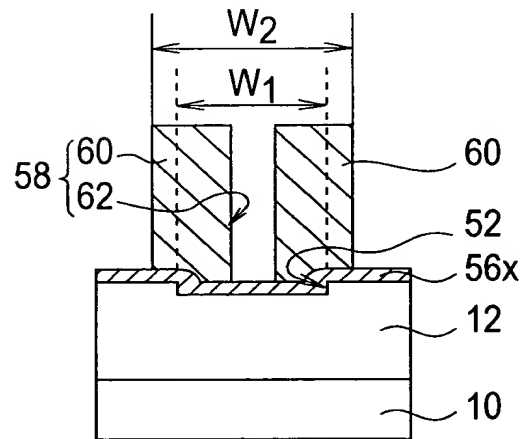


FIG. 8(D)

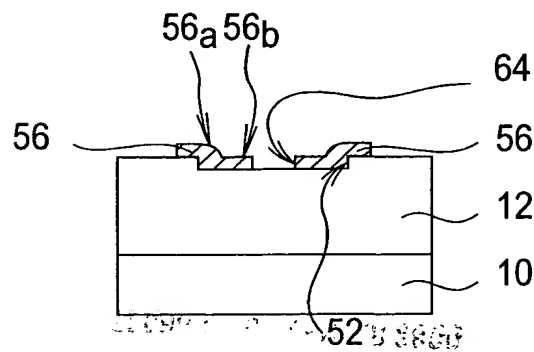




FIG. 9(A)

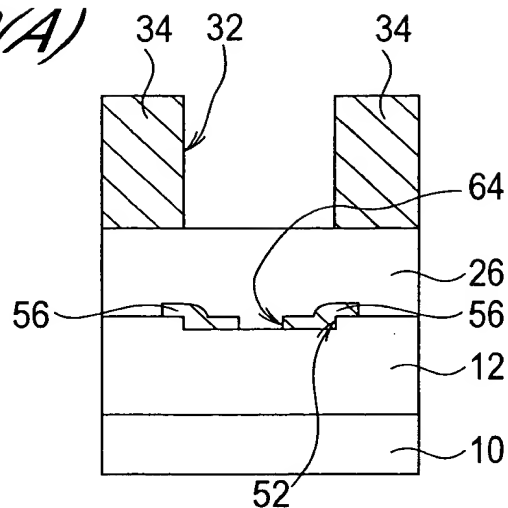


FIG. 9(B)

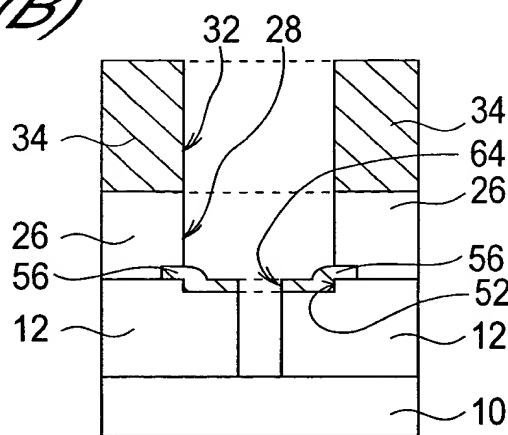


FIG. 9(C)

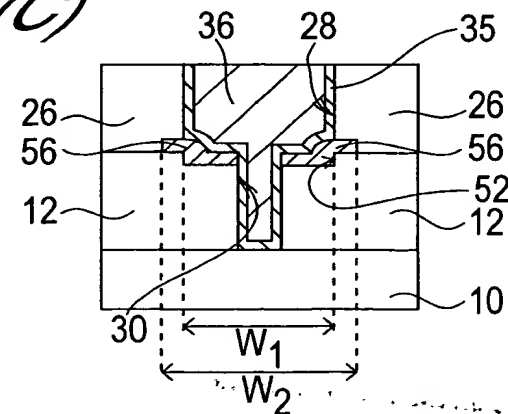




FIG. 10(A)

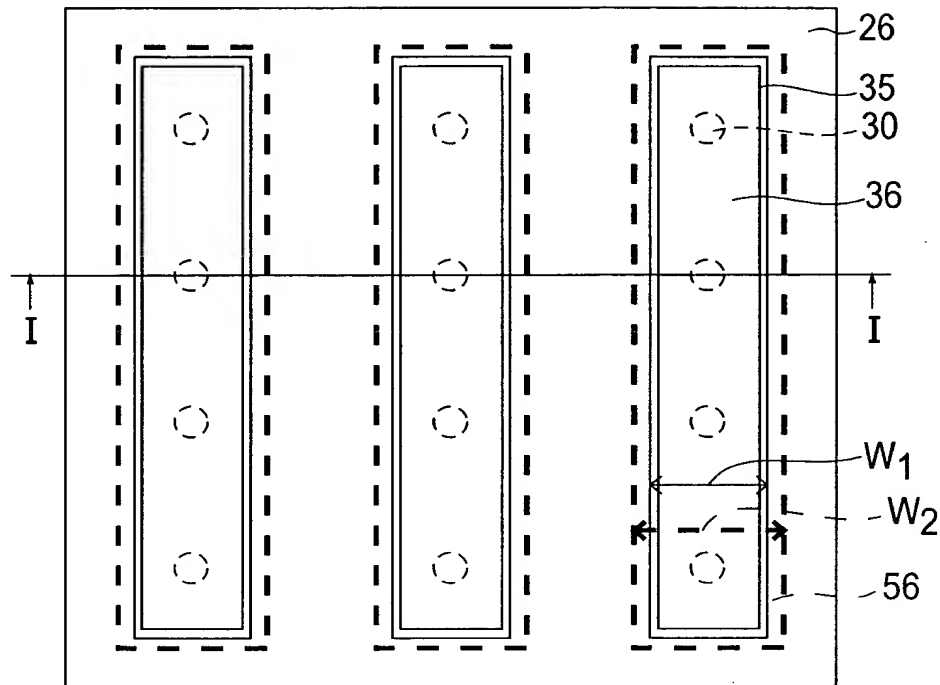
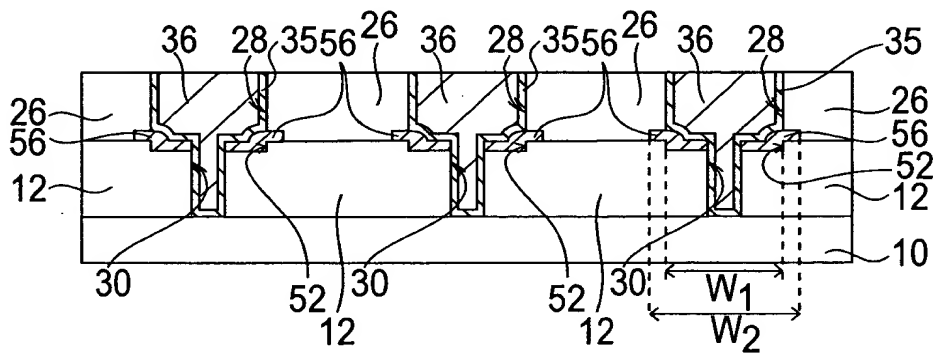


FIG. 10(B)



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FIG. 11(A)

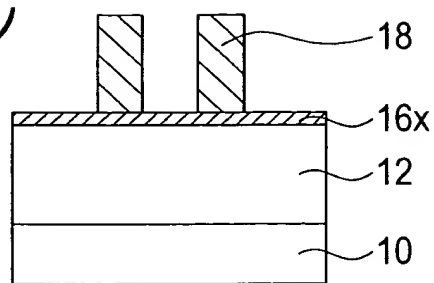


FIG. 11(B)

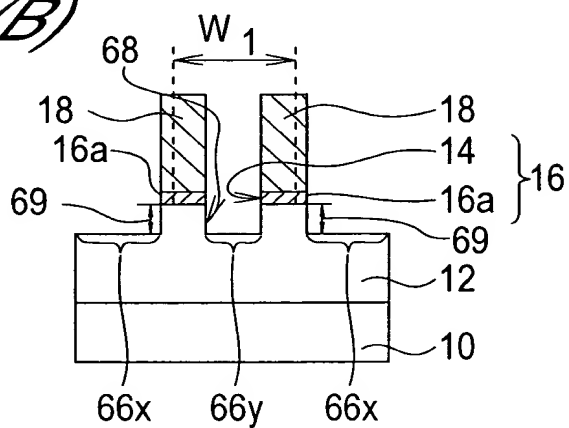


FIG. 11(C)

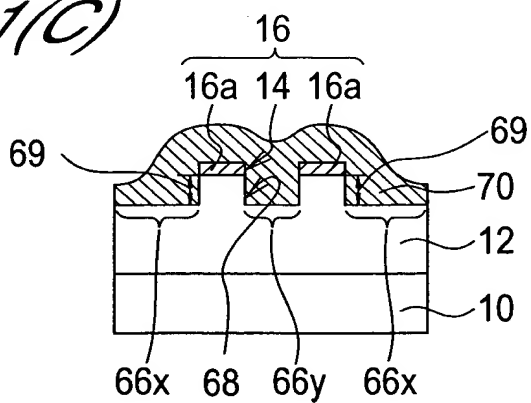
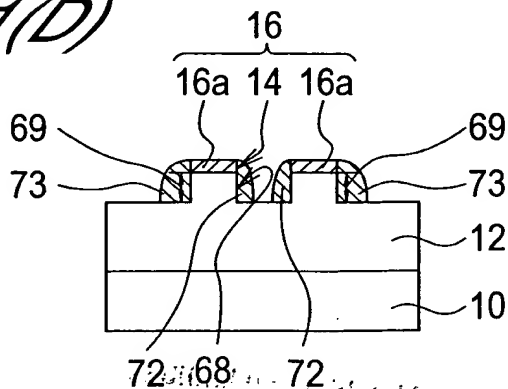


FIG. 11(D)



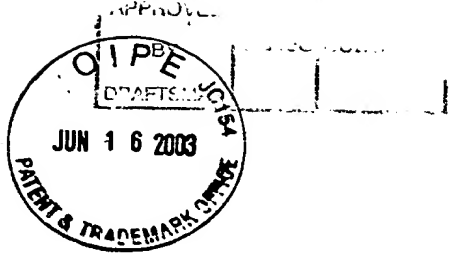


FIG. 12(A)

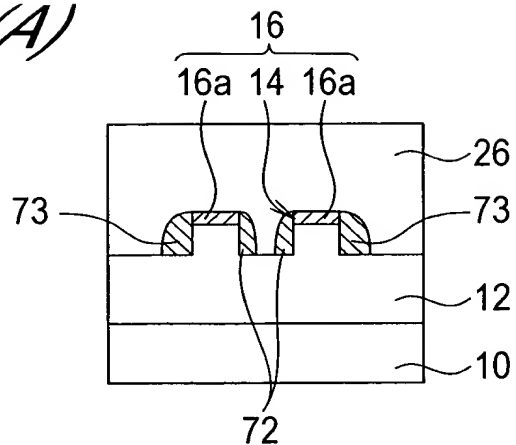


FIG. 12(B)

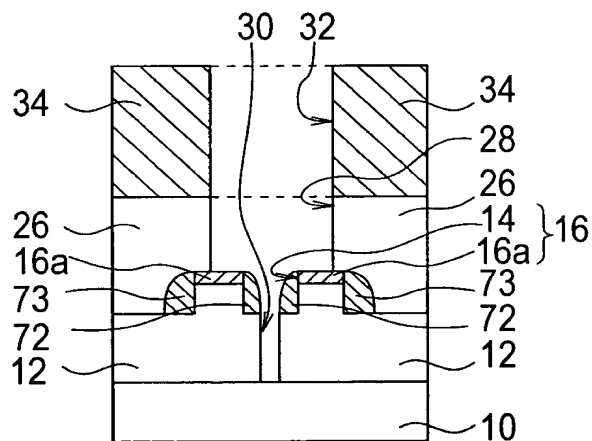
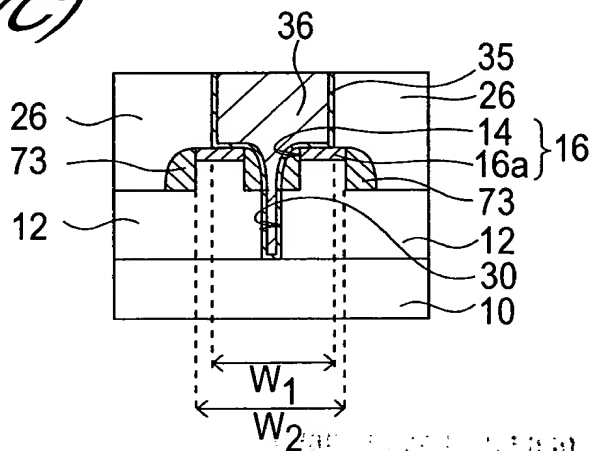


FIG. 12(C)



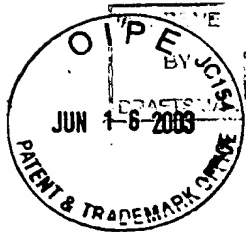


FIG. 14(A)

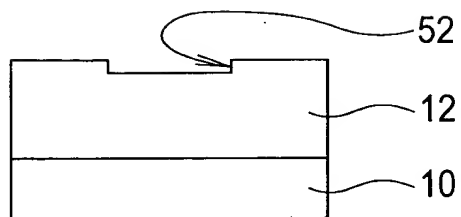


FIG. 14(B)

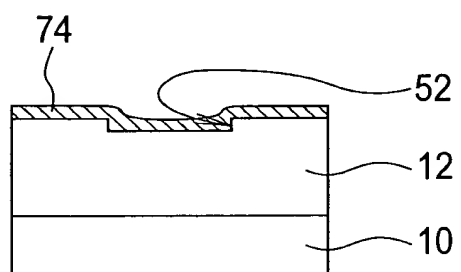


FIG. 14(C)

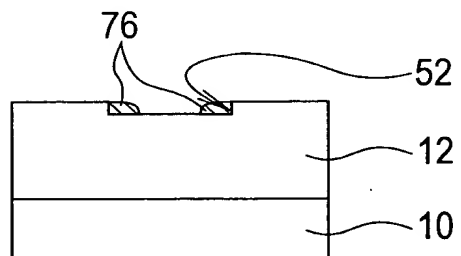


FIG. 14(D)

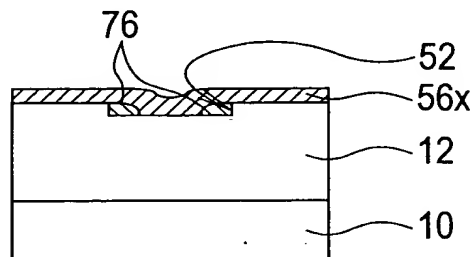




FIG. 15(A)

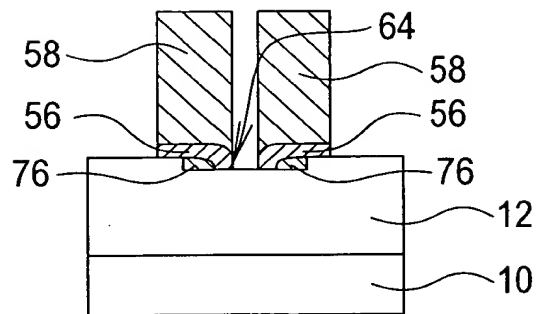


FIG. 15(B)

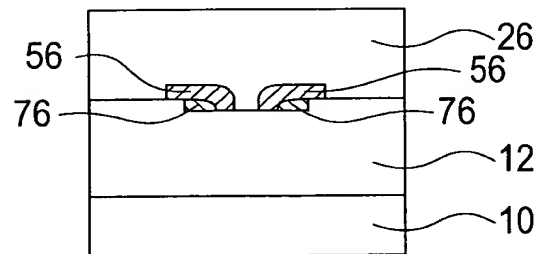


FIG. 15(C)

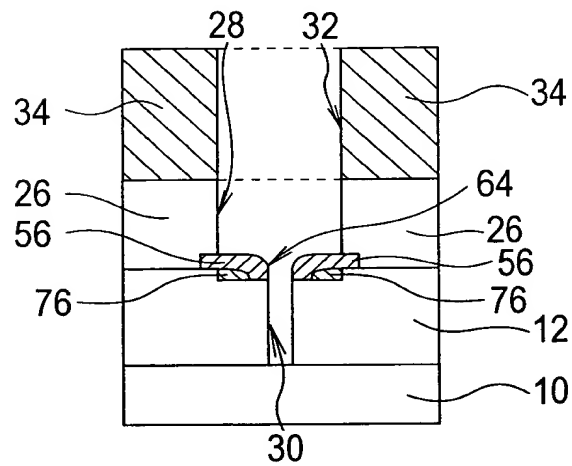


FIG. 15(D)

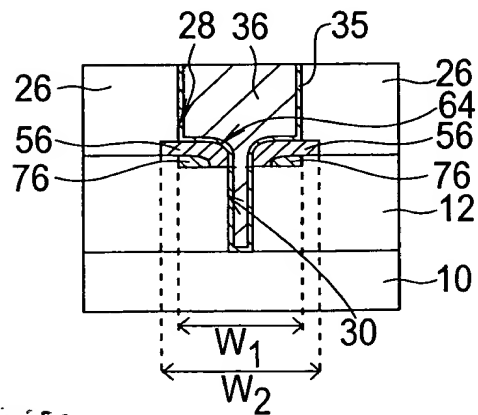




FIG. 16(A)

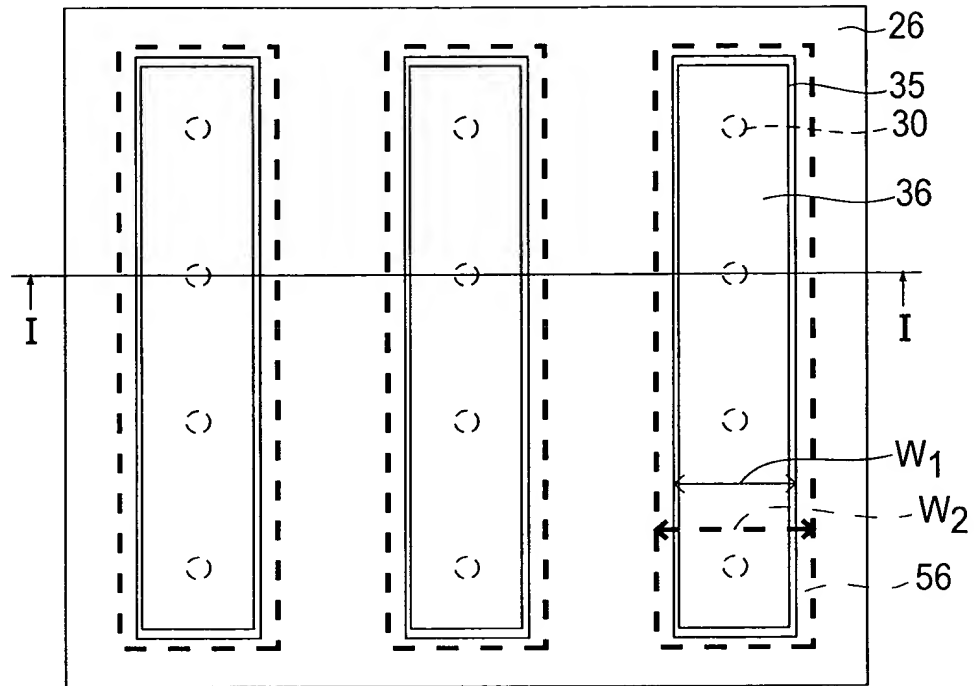


FIG. 16(B)

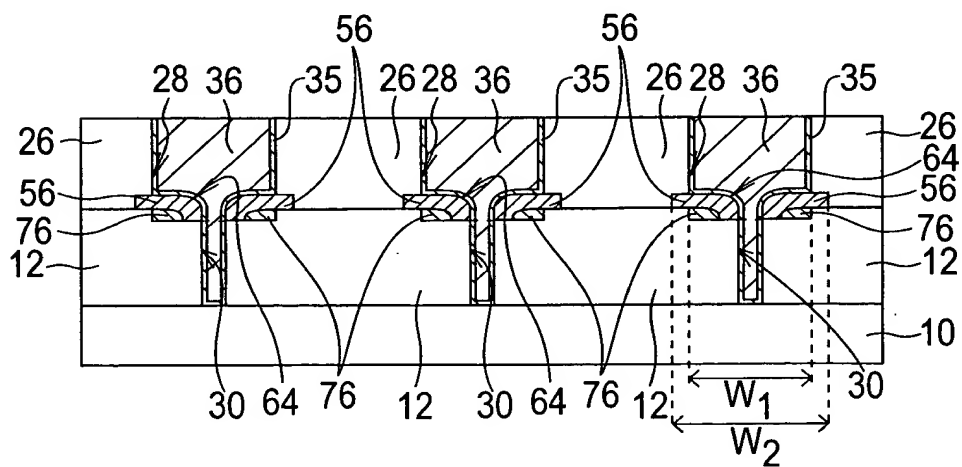




FIG. 17(A)

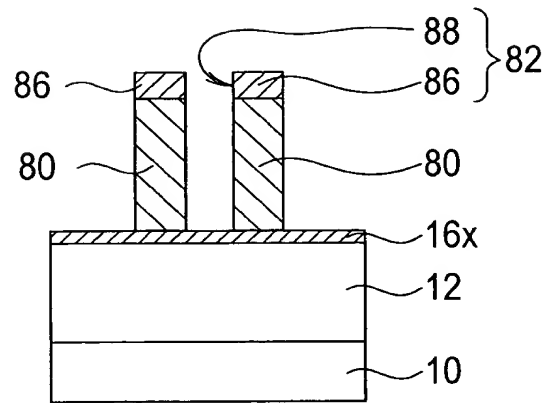


FIG. 17(B)

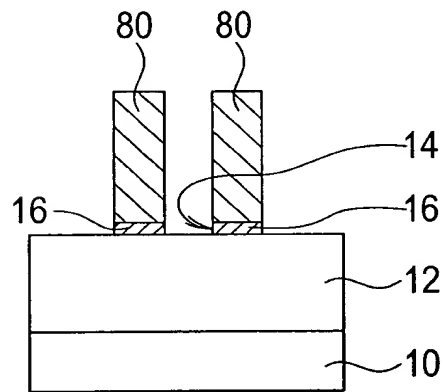
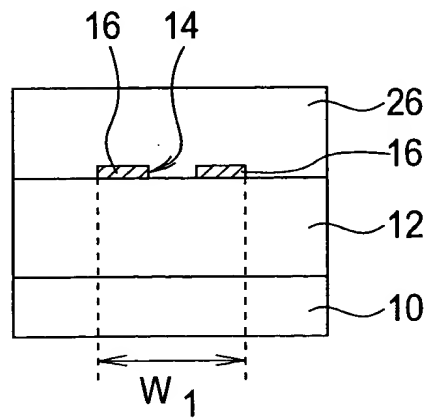


FIG. 17(C)



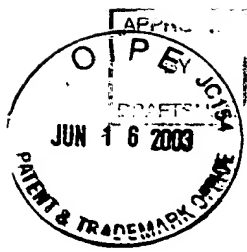


FIG. 18(A)

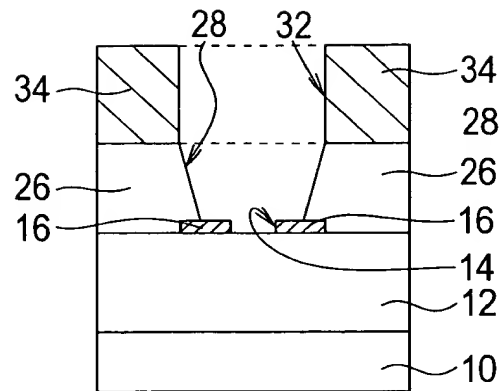


FIG. 18(B)

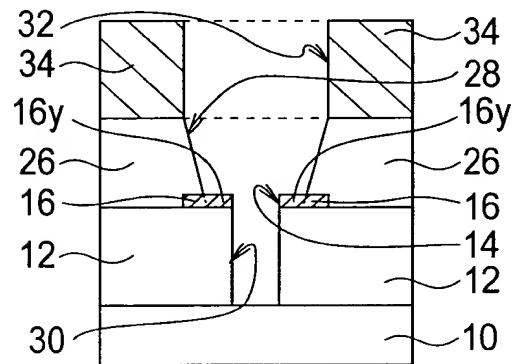


FIG. 18(C)

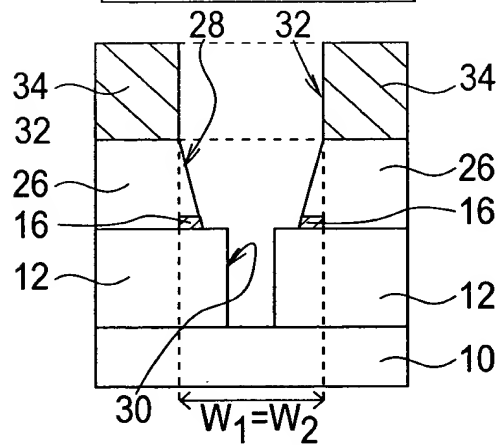


FIG. 18(D)

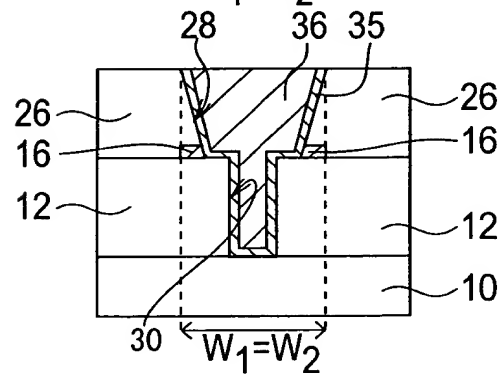




FIG. 19(A)

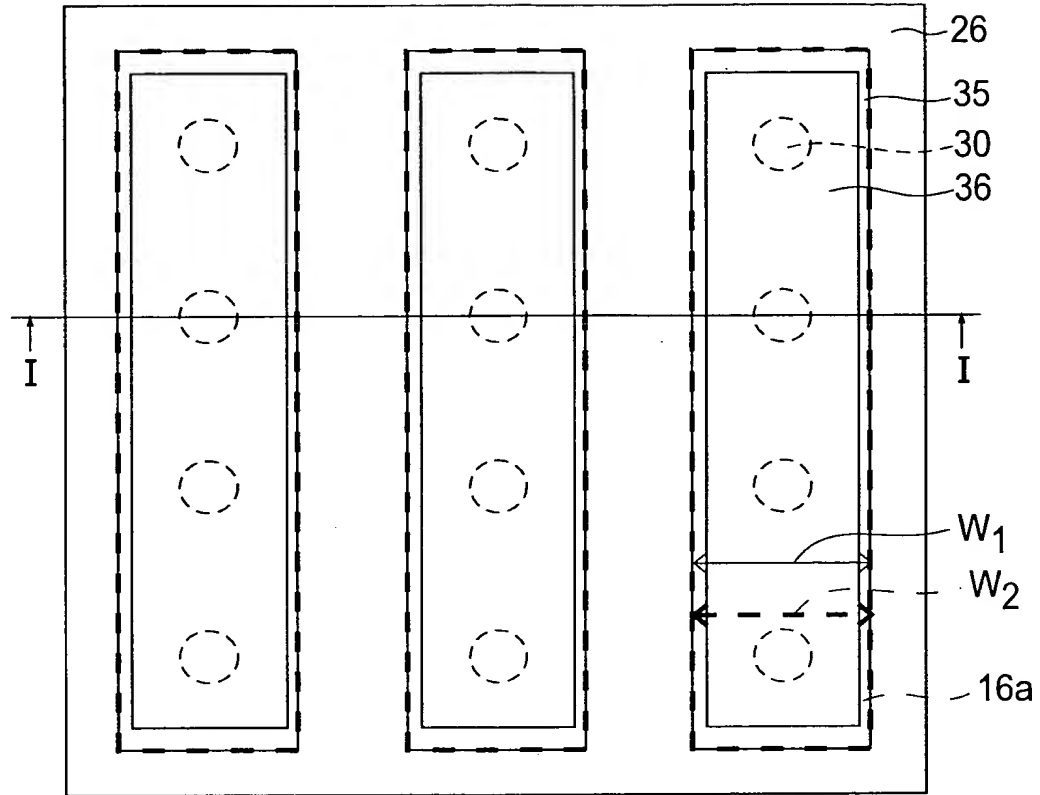
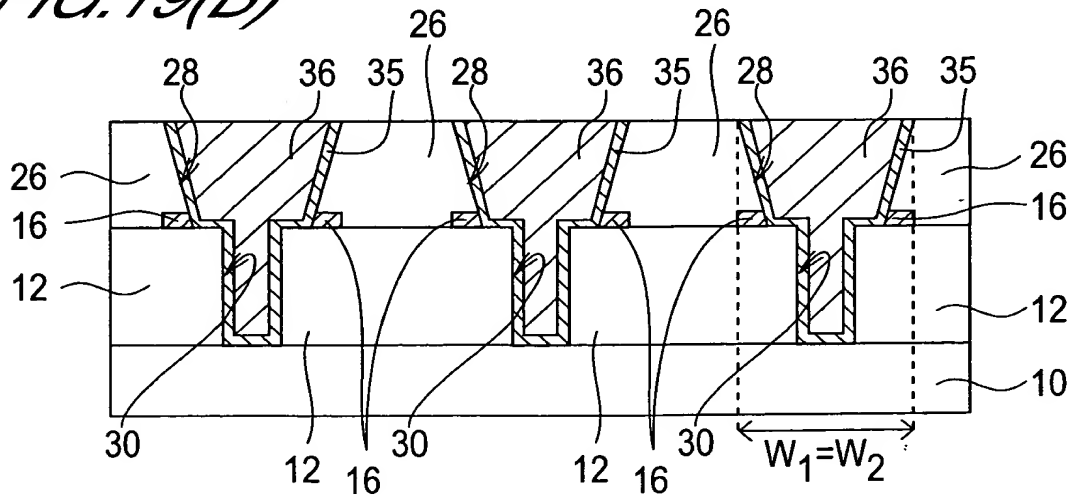


FIG. 19(B)



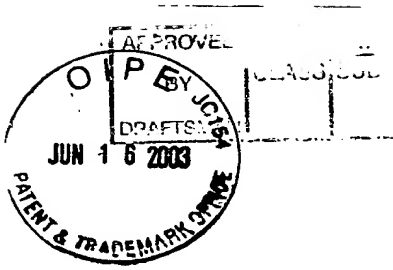
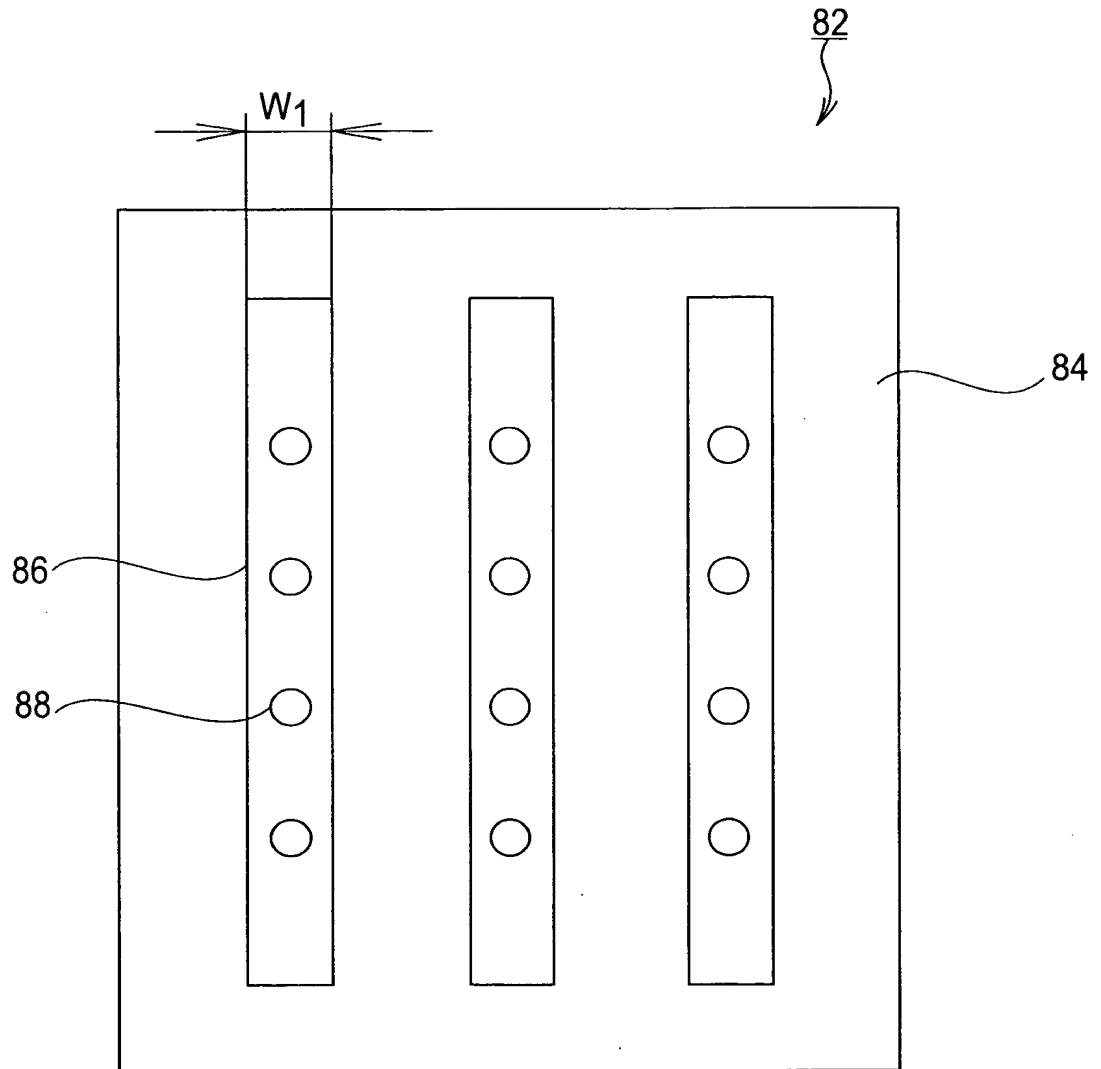


FIG. 20



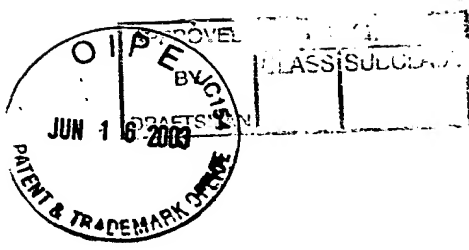


FIG.21(A)

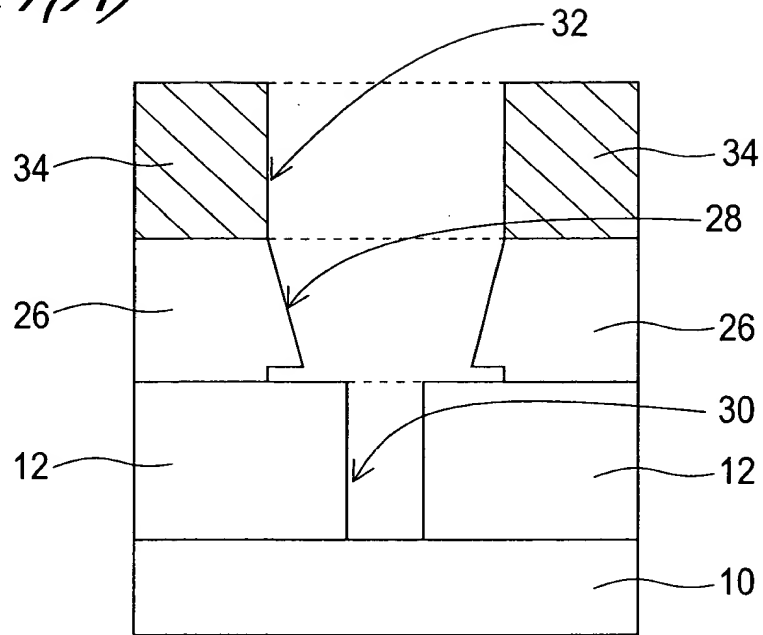
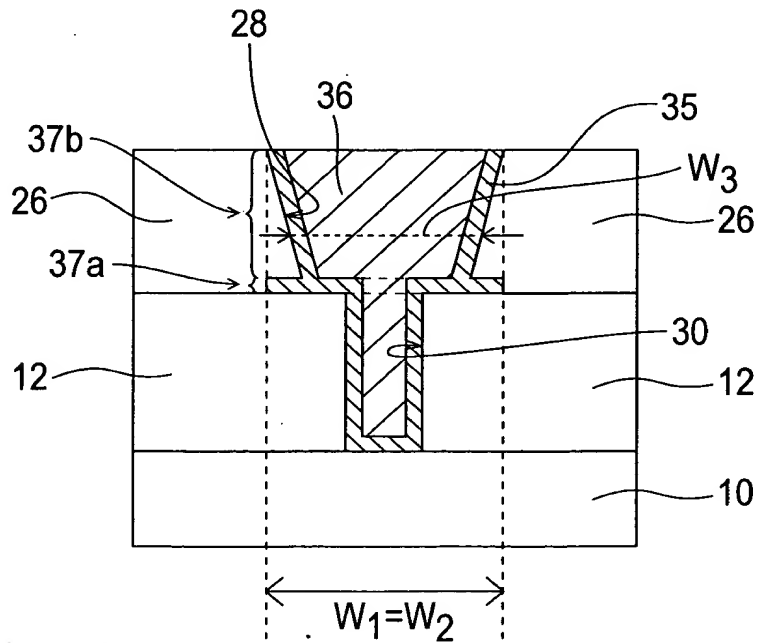


FIG.21(B)



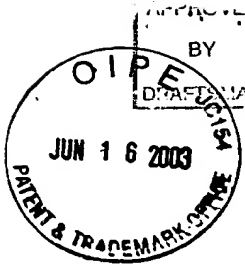


FIG.22(A)

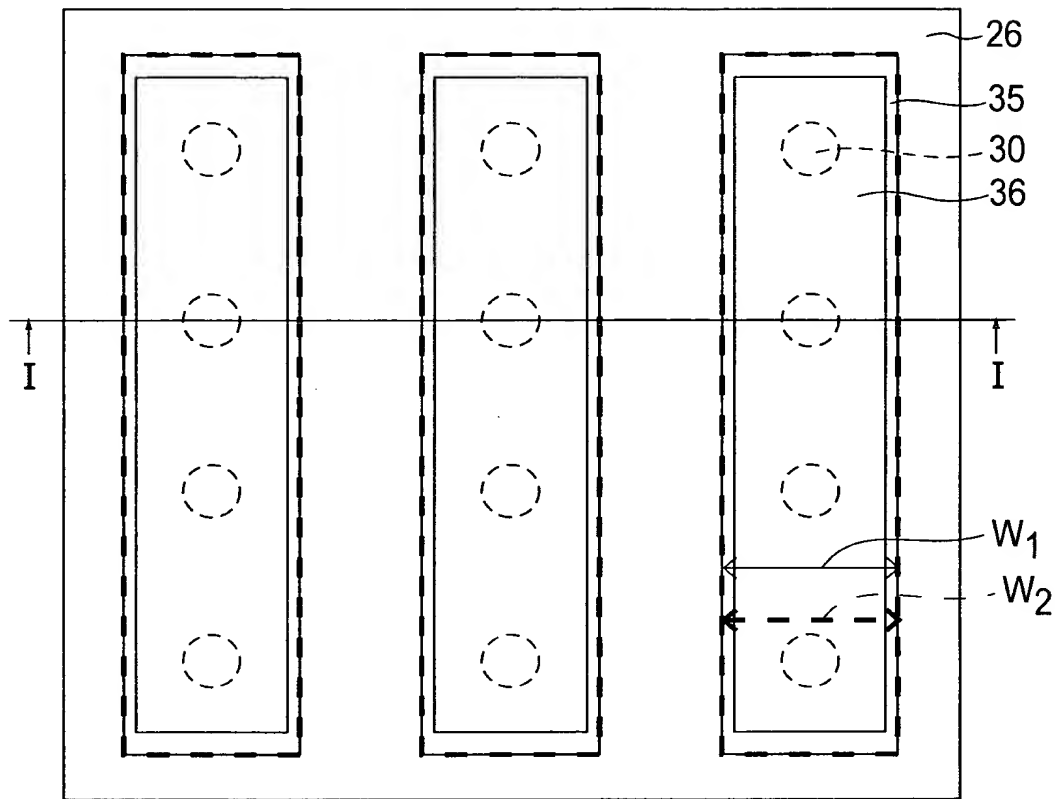


FIG.22(B)

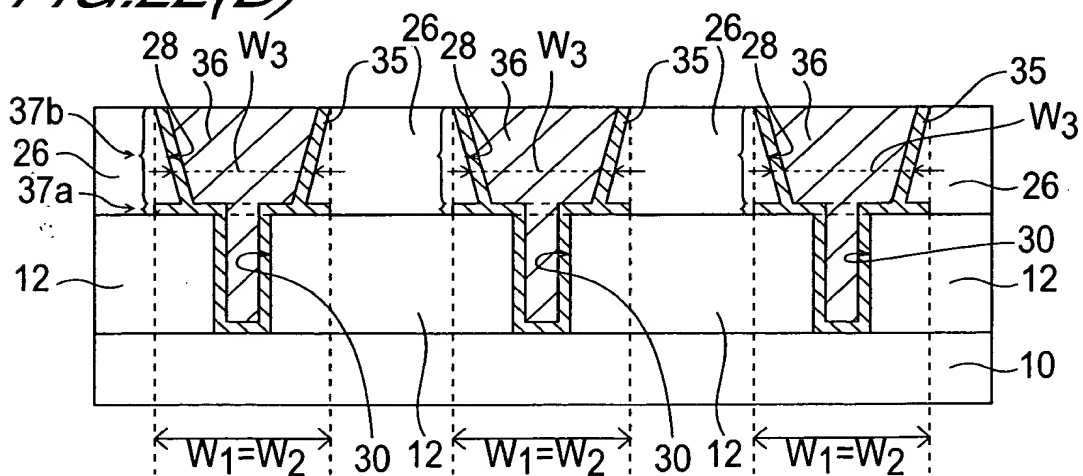




FIG.23(A)

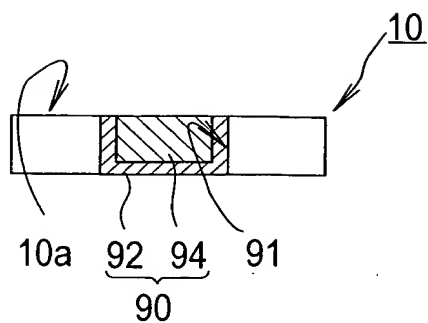


FIG.23(B)

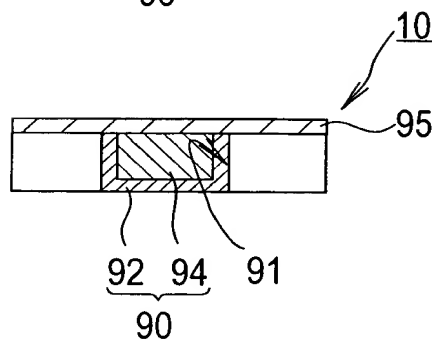


FIG.23(C)

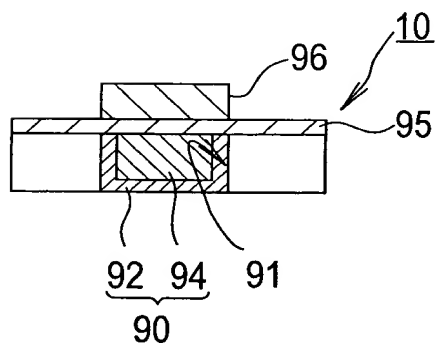


FIG.23(D)

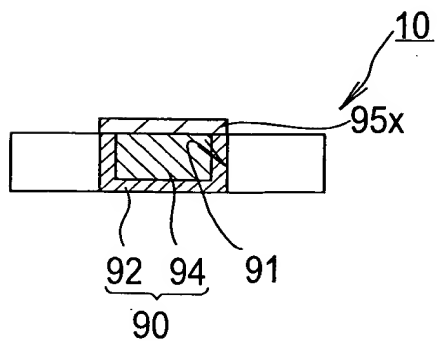




FIG.24(A)

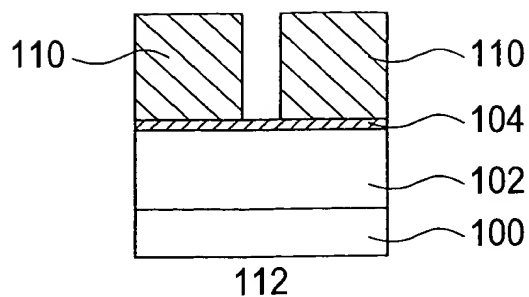


FIG.24(B)

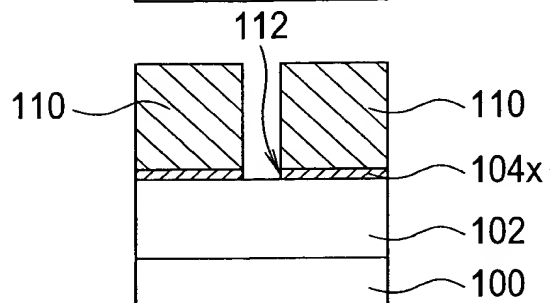


FIG.24(C)

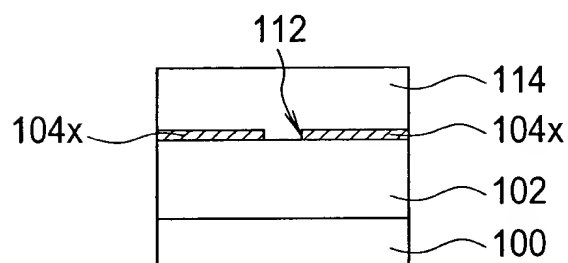


FIG.24(D)

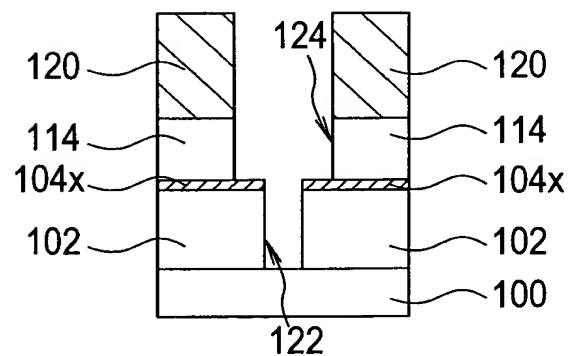


FIG.24(E)

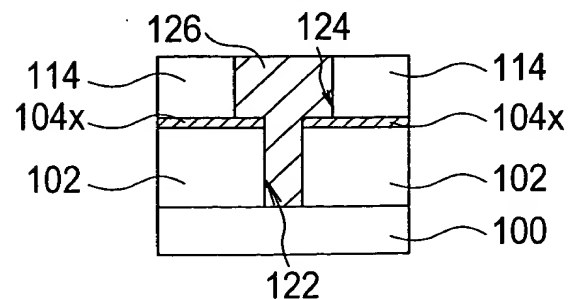




FIG.25

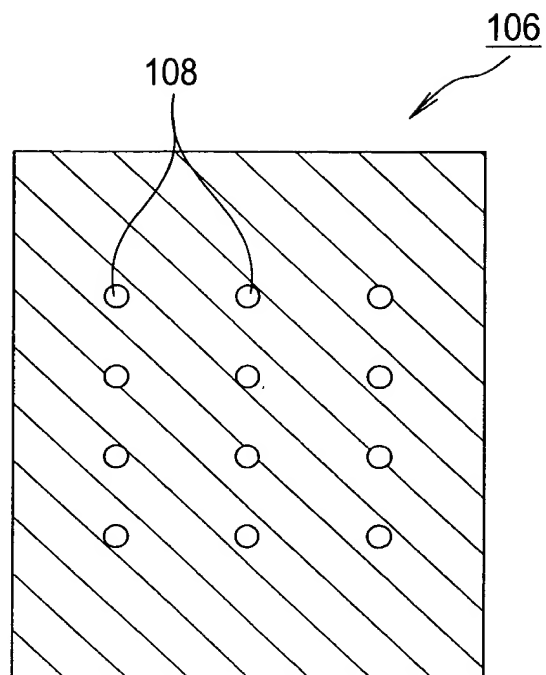
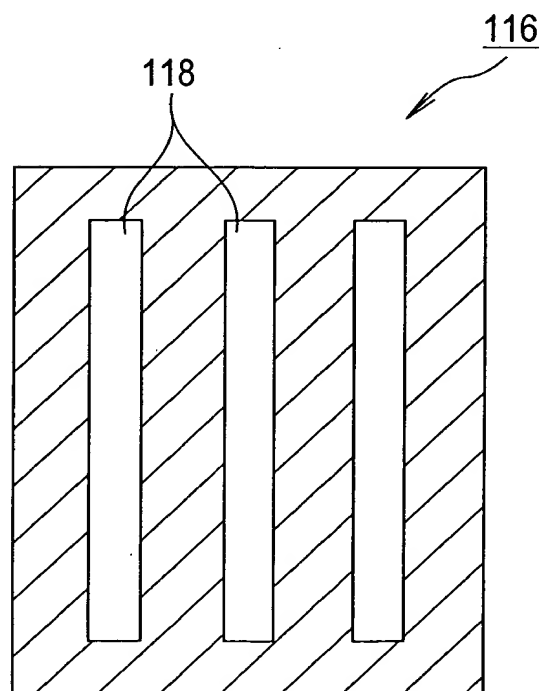


FIG.26



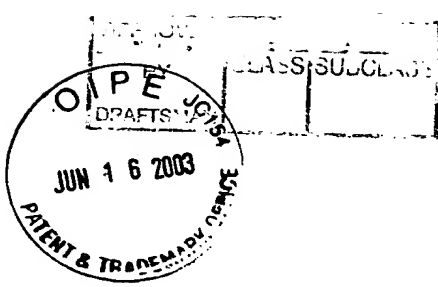


FIG. 27

